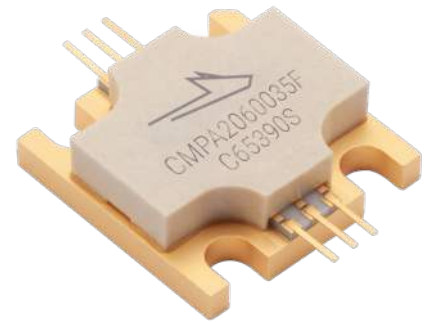


# CMPA2060035F

35 W, 2.0 - 6.0 GHz, GaN MMIC Power Amplifier

## Description

WolfSpeed's CMPA2060035F is a gallium nitride (GaN) High Electron Mobility Transistor (HEMT) based monolithic microwave integrated circuit (MMIC). GaN has superior properties compared to silicon or gallium arsenide, including higher breakdown voltage, higher saturated electron drift velocity and higher thermal conductivity. GaN HEMTs also offer greater power density and wider bandwidths compared to Si and GaAs transistors. This MMIC contains a two-stage reactively matched amplifier enabling very wide bandwidths to be achieved in a small footprint screw-down package featuring a Copper-Tungsten heat-sink.



PN : CMPA2060035F  
Package Type : 440219

## Typical Performance Over 2.0-6.0 GHz, 28 V ( $T_c = 25^\circ\text{C}$ )

Parameter	2.0 GHz	4.0 GHz	6.0 GHz	Units
Small Signal Gain	24.8	26.5	25.0	dB
Output Power <sup>1</sup>	30.0	44.7	32.5	W
Power Gain <sup>1</sup>	17.7	19.5	18.1	dB
Power Added Efficiency <sup>1</sup>	43	47	36	%

Note:

<sup>1</sup>  $V_{DD} = 28\text{ V}$ ,  $I_{DQ} = 1.2\text{ A}$ ,  $P_{IN} = 27\text{ dBm}$ . All data tested CW

### Features

- 28 dB Small Signal Gain
- 35 W Typical  $P_{SAT}$
- Operation up to 28 V
- High Breakdown Voltage
- High Temperature Operation

### Applications

- Ultra Broadband Amplifiers
- Fiber Drivers
- Test Instrumentation
- EMC Amplifier Drivers





### Absolute Maximum Ratings (not simultaneous) at 25°C

Parameter	Symbol	Rating	Units	Conditions
Drain-Source Voltage	$V_{DS}$	84	$V_{DC}$	
Gate-Source Voltage	$V_{GS}$	-10, +2		
Storage Temperature	$T_{STG}$	-65, +150	°C	
Operating Junction Temperature	$T_J$	225		
Forward Gate Current	$I_G$	16	mA	
Screw Torque	$\tau$	40	in-oz	
Thermal Resistance, Junction to Case	$R_{\theta JC}$	2.06	°C/W	85°C, $P_{DISS} = 65$ W, CW
Case Operating Temperature	$T_C$	-40, +150	°C	

### Electrical Characteristics (Frequency = 2.0 GHz to 6.0 GHz unless otherwise stated; $T_C = 25^\circ\text{C}$ )

Characteristics	Symbol	Min.	Typ.	Max.	Units	Conditions
<b>DC Characteristics<sup>1,2</sup></b>						
Gate Quiescent Voltage	$V_{(GS)TH}$	-3.4	-3.0	-2.7	V	$V_{DS} = 10$ V, $I_D = 16.5$ mA
Gate Quiescent Voltage	$V_{(GS)Q}$	—	-2.6	—	$V_{DC}$	$V_{DD} = 28$ V, $I_D = 1.2$ A
Saturated Drain Current <sup>1</sup>	$I_{DS}$	11.9	16.5	—	A	$V_{DS} = 6.0$ V, $V_{GS} = 2.0$ V
Drain-Source Breakdown Voltage	$V_{BD}$	84	—	—	V	$V_{GS} = -8$ V, $I_{DS} = 16.5$ mA
<b>RF Characteristics<sup>3,4,5</sup></b>						
Small Signal Gain	S21	22.2	26.5	—	dB	$V_{DD} = 28$ V, $I_{DQ} = 1.2$ A
Input Return Loss	S11	—	-11	-4		
Output Return Loss	S22	—	-11.6			
Output Power at 2.0 GHz	$P_{OUT}$	23.7	30.0	—	W	
Output Power at 4.0 GHz		34.3	44.7	—		
Output Power at 6.0 GHz		23.7	32.5	—		
Power Added Efficiency at 2.0 GHz	PAE	34.5	43	—	%	
Power Added Efficiency at 4.0 GHz		37	47	—		
Power Added Efficiency at 6.0 GHz		23	36	—		
Output Mismatch Stress	VSWR	—	—	5:1	$\Psi$	No damage at all phase angles, $V_{DD} = 28$ V, $I_{DQ} = 1.2$ A, $P_{IN} = 27$ dBm

Notes:

<sup>1</sup> Measured on-wafer prior to packaging

<sup>2</sup> Scaled from PCM data

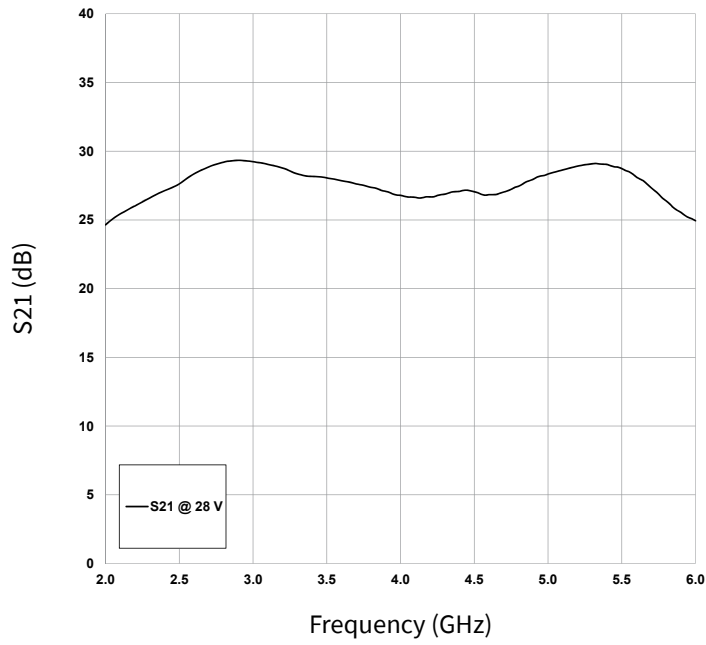
<sup>3</sup> Measured in CMPA2060035F-AMP

<sup>4</sup> Measured at  $P_{IN} = 27$  dBm

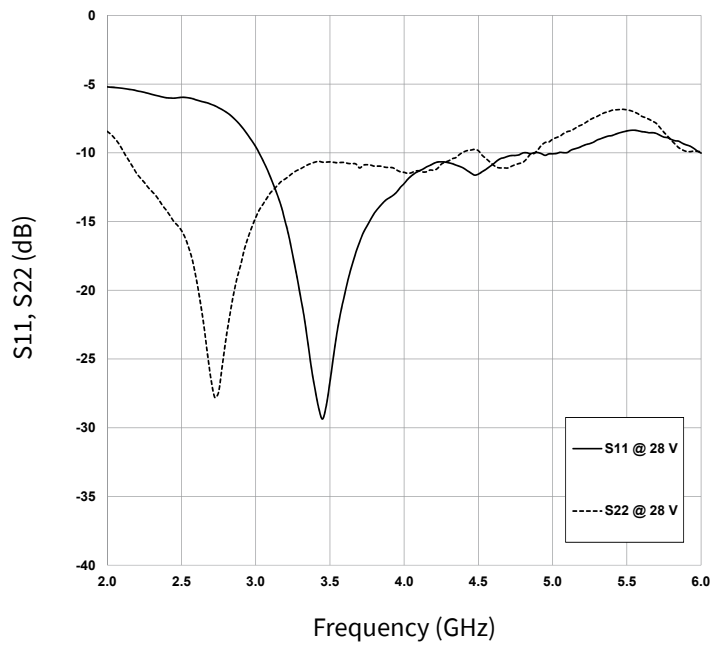
<sup>5</sup> Tested CW



Typical Performance



**Figure 1.** CMPA2060035F S21 vs. Frequency  
 $I_{DQ} = 1.2\text{ A}$



**Figure 2.** CMPA2060035F Return Losses vs. Frequency  
 $I_{DQ} = 1.2\text{ A}$



Typical Performance

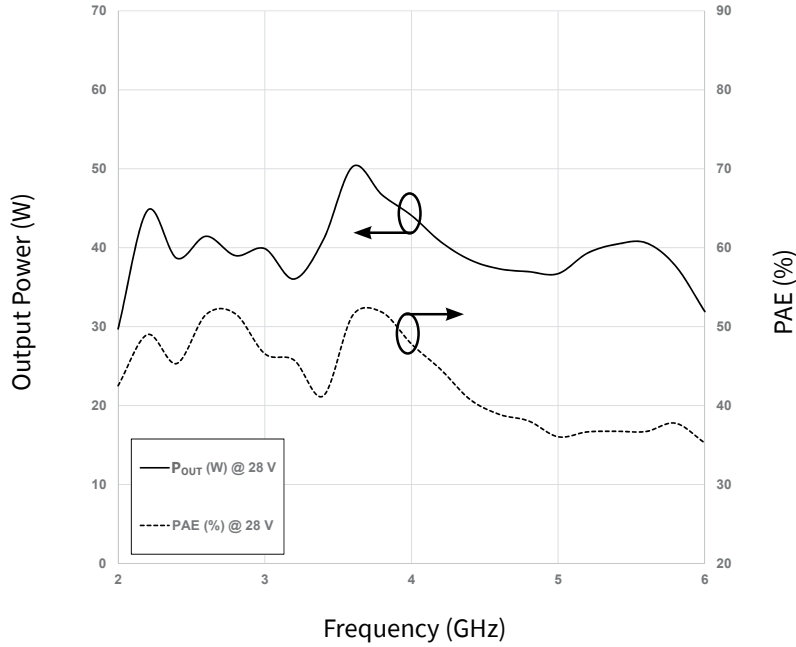


Figure 3. CMA2060035F Output Power and Power Added Efficiency vs. Frequency  
 $I_{DQ} = 1.2$  A, Case Temperature = 25°C, Power Input = 27 dBm

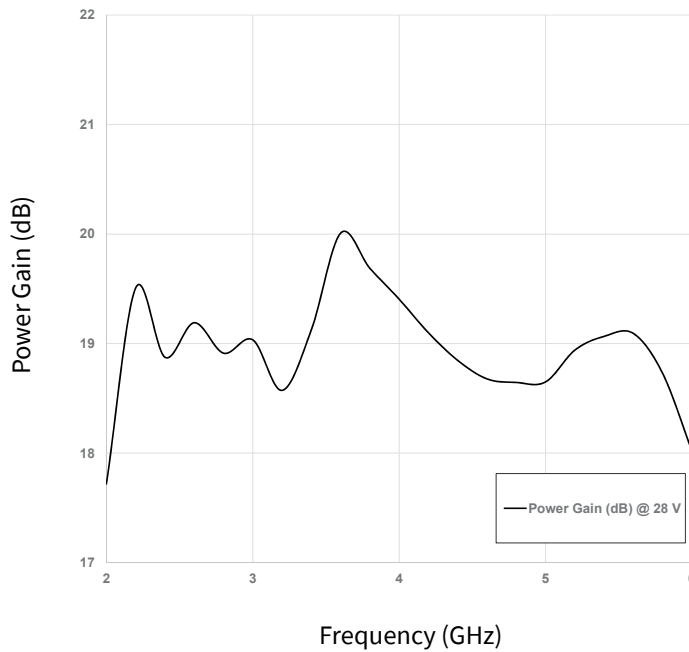
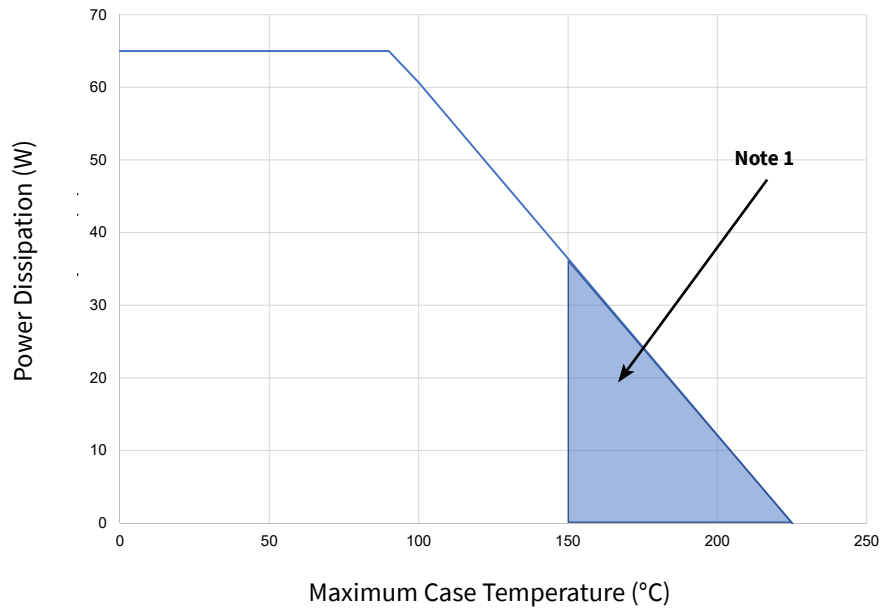


Figure 4. CMA2060035F Power Gain vs. Frequency  
 $I_{DQ} = 1.2$  A



## Typical Performance



**Figure 5.** CMPA2060035F CW Power Dissipation De-rating Curve

Notes:

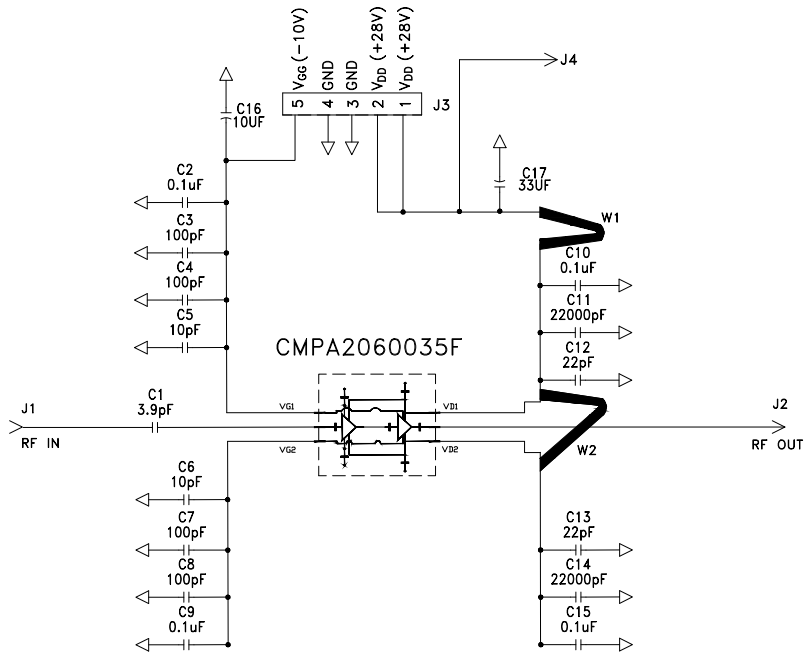
<sup>1</sup> Area exceeds Maximum Case Operating Temperature (See Page 2).

## Electrostatic Discharge (ESD) Classifications

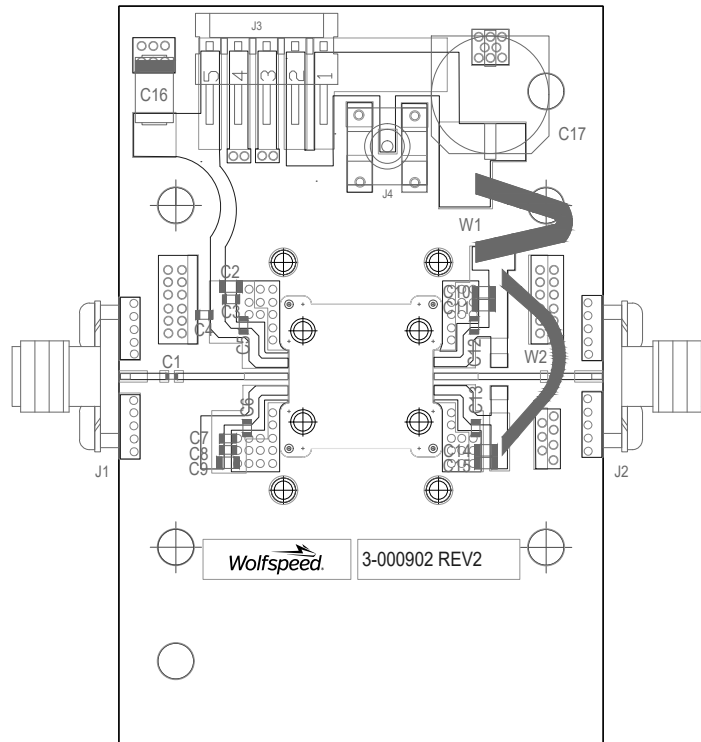
Parameter	Symbol	Class	Classification Level	Test Methodology
Human Body Model	HBM	1A	ANSI/ESDA/JEDEC JS-001 Table 3	JEDEC JESD22 A114-D
Charge Device Model	CDM	C3	ANSI/ESDA/JEDEC JS-002 Table 3	JEDEC JESD22 C101-C



### CMPA2060035F-AMP Demonstration Amplifier Circuit Schematic



### CMPA2060035F-AMP Demonstration Amplifier Circuit Outline



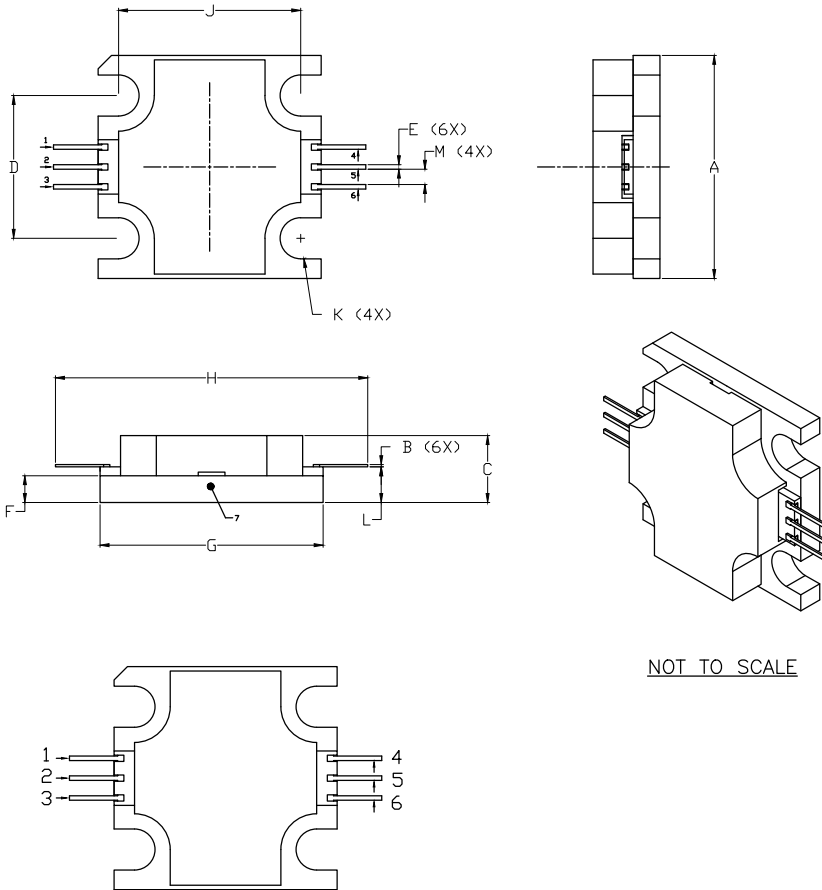


## CMPA2060035F-AMP Demonstration Amplifier Circuit Bill of Materials

Designator	Description	Qty
	PCB	1
Q1	CMPA2060035F, 2.0-6.0GHz, GaN MMIC	1
C1	CAP, 3.9pF, +/-0.1pF, 0402, ATC	1
C2, C9, C10, C15	CAP CER 0.1μF 100V 10% X7R 0805	4
C3, C4, C7, C8	CAP, 100.0pF, +/-5%, 0603, ATC	4
C5, C6	CAP, 10.0pF, +/-5%, 0603, ATC	2
C11, C14	CAP CER 22,000pF 100V 10% X7R 0805	2
C12, C13	CAP, 22pF, +/-5%, 0603, ATC	2
C16	CAP 10μF 16V TANTALUM, 2312	1
C17	CAP, 33μF, 20%, G CASE	1
J1,J2	CONN, SMA, PANEL MOUNT JACK, FLANGE, 4-HOLE, BLUNT POST, 20MIL	2
J3	HEADER RT>PLZ .1CEN LK 5POS	1
J4	CONN, SMB, STRAIGHT JACK RECEPTACLE, SMT, 50 OHM, Au PLATED	1
W1, W2	WIRE, BLACK, 22 AWG	2
	WIRE ASSEMBLY, 5-PIN, MMIC HPA FIXTURES	1
	CLAMP, DELRIN	2
	2-56 SOC HD SCREW 3/16 SS	4
	2-56 SOC HD SCREW 1/2 SS	4
	PREFORM, INDIUM, 2 X 2 X 0.003" THK, WITH 0.0002" THK AL CLAD ON ONE SIDE	1
	TEST FIXTURE INSTRUCTIONS	1



**Product Dimensions CMPA2060035F (Package Type – 440219)**



NOTES:

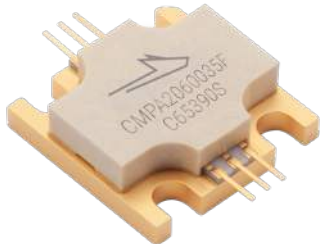

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. ADHESIVE FROM LID MAY EXTEND A MAXIMUM OF 0.020" BEYOND EDGE OF LID.
4. LID MAY BE MISALIGNED TO THE BODY OF THE PACKAGE BY A MAXIMUM OF 0.008" IN ANY DIRECTION.
5. ALL PLATED SURFACES ARE NI/AU

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.495	0.505	12.57	12.82
B	0.003	0.005	0.076	0.127
C	0.140	0.160	3.56	4.06
D	0.315	0.325	8.00	8.25
E	0.008	0.012	0.204	0.304
F	0.055	0.065	1.40	1.65
G	0.495	0.505	12.57	12.82
H	0.695	0.705	17.65	17.91
J	0.403	0.413	10.24	10.49
K	∅ .092		2.34	
L	0.075	0.085	1.905	2.159
M	0.032	0.040	0.82	1.02

PIN	Function
1	Gate 1
2	RF <sub>IN</sub>
3	Gate 2
4	Drain 1
5	RF <sub>OUT</sub>
6	Drain 2
7	Ground



**Product Ordering Information**

Order Number	Description	Unit of Measure	Image
CMPA2060035F	GaN MMIC	Each	
CMPA2060035F-AMP	Test board with GaN MMIC installed	Each	

**For more information, please contact:**

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## Notes & Disclaimer

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